

January 2010

# BAT42XV2-BAT43XV2 **Schottky Barrier Diodes**

#### **Features**

- Low Forward Voltage Drop
- Flat Lead, Surface Mount Device at 0.60mm Height
- Extremely Small Outline Plastic Package SOD523F
- · Moisture Level Sensitivity 1
- · Pb-free Version and RoHS Compliant
- Matte Tin (Sn) Lead Finish
- · Green Mold Compound



**ELECTRICAL SYMBOL** 



BAT42XV2 Marking: 6B BAT43XV2 Marking: 7B

Band Indicates Cathode

# **Absolute Maximum Ratings \*** T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{RRM}$	Maximum Repetitive Reverse Voltage	30	V
V <sub>R</sub>	Maximum DC Blocking Voltage	30	V
I <sub>F(AV)</sub>	Average Rectified Forward Current	200	mA
I <sub>FSM</sub>	Peak Forward Surge Current	4	А
TJ	Operating Junction Temperature	+125	°C
T <sub>STG</sub>	Storage Temperature Range	-65 to +125	°C

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

# **Thermal Characteristics** T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
$P_{D}$	Power Dissipation	200	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	500	°C/W

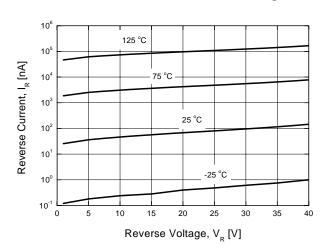
<sup>\*</sup> Device mounted on FR-4 PCB minimum land pad.

# **Electrical Characteristics** T<sub>A</sub>=25°C unless otherwise noted

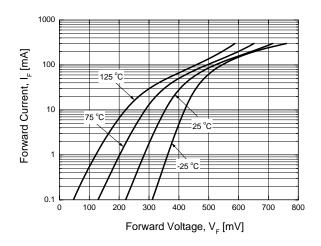
Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV <sub>R</sub>	Breakdown Voltage	I <sub>R</sub> =100μA	30			V
I <sub>R</sub>	Reverse Leakage Current	V <sub>R</sub> =25V			500	nA
V <sub>F</sub>	Forward Voltage BAT42XV2	I <sub>F</sub> =10mA			0.40	
		I <sub>F</sub> =50mA			0.65	
	BAT43XV2	I <sub>F</sub> =2mA	0.26		0.33	V
		I <sub>F</sub> =15mA			0.45	
	BAT42XV2, BAT43XV2	I <sub>F</sub> =200mA			1.0	
T <sub>RR</sub>	Reverse Recovery Time	I <sub>F</sub> =I <sub>R</sub> =10mA		5		nS
		$R_L=100\Omega$				
		I <sub>RR</sub> =1mA				
С	Capacitance	V <sub>R</sub> =1V, f=1MHz		7		pF

# **Typical Performance Characteristics**

## **Reverse Current vs Reverse Voltage**

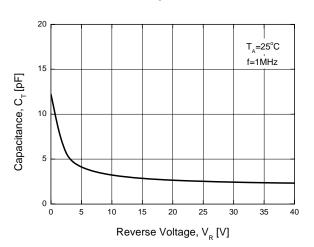


## **Forward Voltage vs Forward Current**

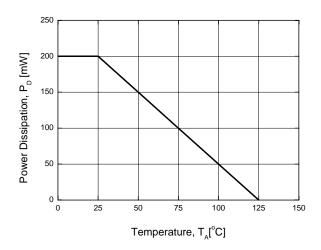


# Typical Performance Characteristics (Continued)

# **Total Capacitance**

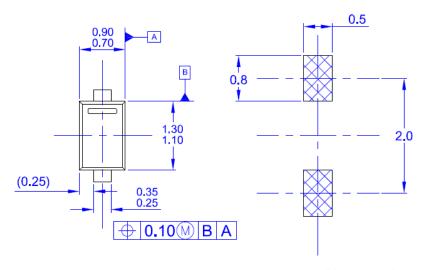


# **Power Derating Curve**



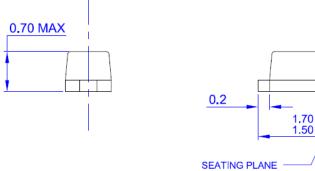
# **Physical Dimension**

## **SOD-523F**



LAND PATTERN RECOMMENDATION

0.2 MAX



NOTES: UNLESS OTHERWISE SPECIFIED

- A) PACKAGE REFERENCE: THIS PACKAGE OUTLINE CONFORMS TO JEITA SC-79.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.

- C) DRAWING CONFORMS TO ASME Y14,5M 1994
  D) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
  E) LANDPATTERN RECOMMENDATION IS BASED ON IPC7351A STANDARD SOD1609X65M,
- F) DRAWING NUMBER AND REVISION:MKT-SOD523F1rev1





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Definition of Terms				
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